Preferred Device

# **Silicon Power Transistors**

The MJ21193 (PNP) and MJ21194 (NPN) utilize Perforated Emitter technology and are specifically designed for high power audio output, disk head positioners and linear applications.

#### Features

- Total Harmonic Distortion Characterized
- High DC Current Gain  $h_{FE} = 25 \text{ Min} @ I_C = 8 \text{ Adc}$
- Excellent Gain Linearity
- High SOA: 2.5 A, 80 V, 1 Second
- Pb-Free Packages are Available\*

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V <sub>CEO</sub>	250	Vdc
Collector-Base Voltage	V <sub>CBO</sub>	400	Vdc
Emitter-Base Voltage	V <sub>EBO</sub>	5	Vdc
Collector-Emitter Voltage - 1.5 V	$V_{CEX}$	400	Vdc
Collector Current – Continuous Peak (Note 1)	Ι <sub>C</sub>	16 30	Adc
Base Current – Continuous	Ι <sub>Β</sub>	5	Adc
Total Power Dissipation @ $T_C = 25^{\circ}C$ Derate Above 25°C	PD	250 1.43	W W/°C
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	– 65 to +200	°C

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	0.7	°C/W

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

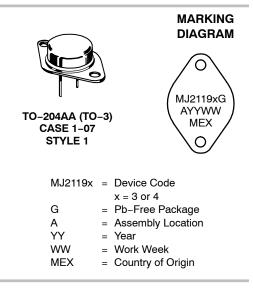
1. Pulse Test: Pulse Width = 5  $\mu$ s, Duty Cycle  $\leq$  10%. (continued)



## **ON Semiconductor®**

http://onsemi.com

## 16 AMP COMPLEMENTARY SILICON POWER TRANSISTORS 250 VOLTS, 250 WATTS



### ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
MJ21193	TO-3	100 Units / Tray
MJ21193G	TO-3 (Pb-Free)	100 Units / Tray
MJ21194	TO-3	100 Units / Tray
MJ21194G	TO-3 (Pb-Free)	100 Units / Tray

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

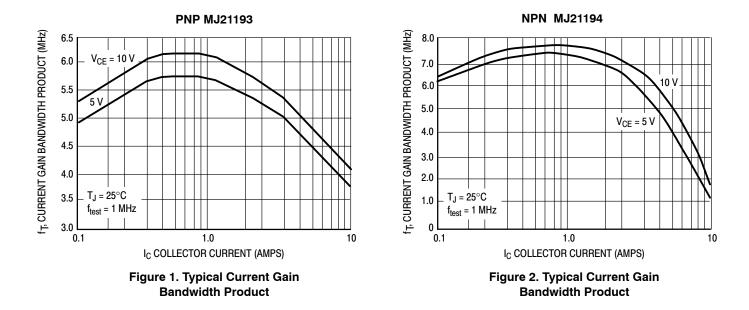
**Preferred** devices are recommended choices for future use and best overall value.

© Semiconductor Components Industries, LLC, 2009 April, 2009 – Rev. 5

#### **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS			1		
Collector–Emitter Sustaining Voltage $(I_C = 100 \text{ mAdc}, I_B = 0)$	V <sub>CEO(sus)</sub>	250	-	-	Vdc
Collector Cutoff Current (V <sub>CE</sub> = 200 Vdc, I <sub>B</sub> = 0)	I <sub>CEO</sub>	-	-	100	μAdc
Emitter Cutoff Current ( $V_{CE} = 5 \text{ Vdc}, I_C = 0$ )	I <sub>EBO</sub>	-	-	100	μAdc
Collector Cutoff Current (V <sub>CE</sub> = 250 Vdc, V <sub>BE(off)</sub> = 1.5 Vdc)	I <sub>CEX</sub>	-		100	μAdc
SECOND BREAKDOWN					
Second Breakdown Collector Current with Base Forward Biased (V <sub>CE</sub> = 50 Vdc, t = 1 s (non-repetitive) (V <sub>CE</sub> = 80 Vdc, t = 1 s (non-repetitive)	I <sub>S/b</sub>	5 2.5			Adc
ON CHARACTERISTICS					
DC Current Gain ( $I_C = 8 \text{ Adc}, V_{CE} = 5 \text{ Vdc}$ ) ( $I_C = 16 \text{ Adc}, I_B = 5 \text{ Adc}$ )	h <sub>FE</sub>	25 8		75	
Base–Emitter On Voltage (I <sub>C</sub> = 8 Adc, V <sub>CE</sub> = 5 Vdc)	V <sub>BE(on)</sub>	-	-	2.2	Vdc
Collector–Emitter Saturation Voltage ( $I_C = 8 \text{ Adc}, I_B = 0.8 \text{ Adc}$ ) ( $I_C = 16 \text{ Adc}, I_B = 3.2 \text{ Adc}$ )	V <sub>CE(sat)</sub>			1.4 4	Vdc
DYNAMIC CHARACTERISTICS					
Total Harmonic Distortion at the Output V <sub>RMS</sub> = 28.3 V, f = 1 kHz, P <sub>LOAD</sub> = 100 W <sub>RMS</sub> h <sub>FE</sub> unmatched	T <sub>HD</sub>	_	0.8	_	%
(Matched pair $h_{FE} = 50 @ 5 A/5 V$ ) $h_{FE}$ matched		-	0.08	_	
Current Gain Bandwidth Product ( $I_C = 1 \text{ Adc}, V_{CE} = 10 \text{ Vdc}, f_{test} = 1 \text{ MHz}$ )	f <sub>T</sub>	4	-	-	MHz
Output Capacitance (V <sub>CB</sub> = 10 Vdc, I <sub>E</sub> = 0, f <sub>test</sub> = 1 MHz)	C <sub>ob</sub>	-	-	500	pF

NOTE: Pulse Test: Pulse Width = 300  $\mu s,$  Duty Cycle  ${\leq}2\%$ 



http://onsemi.com 2

#### **TYPICAL CHARACTERISTICS**

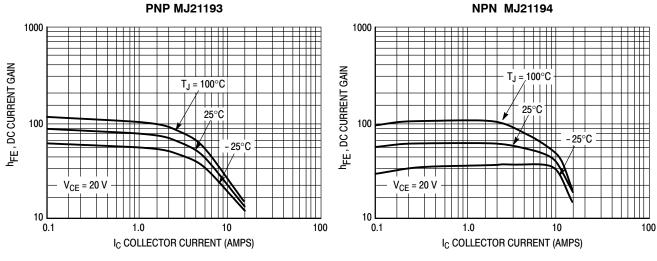


Figure 3. DC Current Gain, V<sub>CE</sub> = 20 V



PNP MJ21193



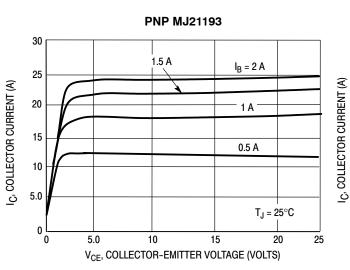
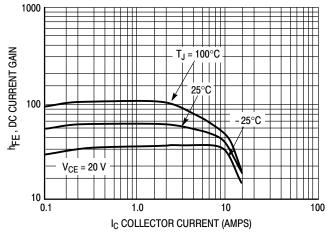


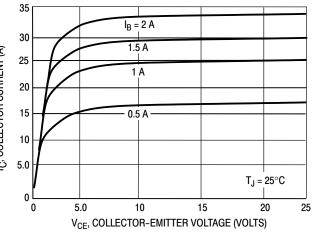
Figure 7. Typical Output Characteristics

NPN MJ21194



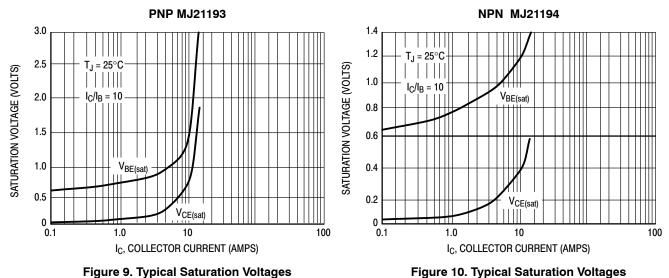


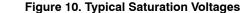






#### **TYPICAL CHARACTERISTICS**





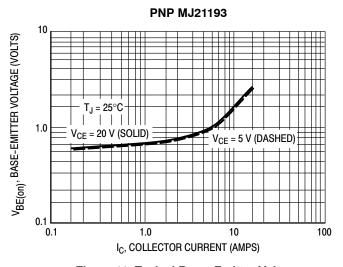


Figure 11. Typical Base-Emitter Voltage



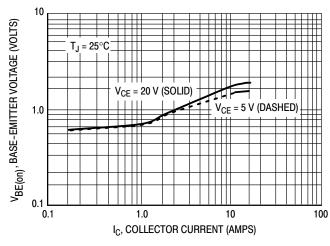


Figure 12. Typical Base-Emitter Voltage

There are two limitations on the power handling ability of a transistor; average junction temperature and secondary breakdown. Safe operating area curves indicate IC - VCE limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 13 is based on  $T_{J(pk)} = 200^{\circ}C$ ;  $T_C$  is variable depending on conditions. At high case temperatures, thermal limitations will reduce the power than can be handled to values less than the limitations imposed by second breakdown.

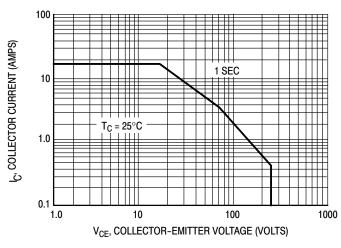


Figure 13. Active Region Safe Operating Area

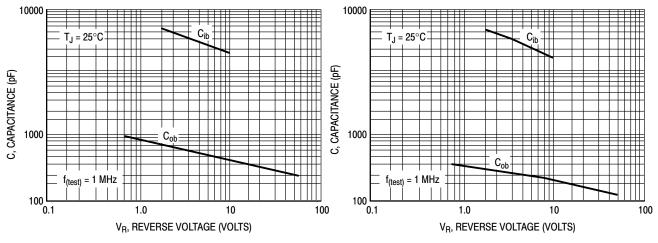
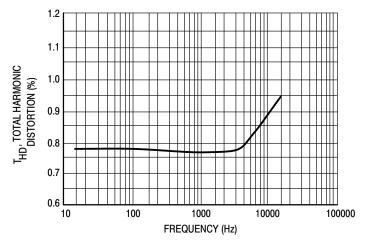
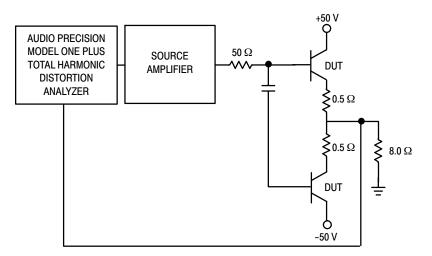


Figure 14. MJ21193 Typical Capacitance

Figure 15. MJ21194 Typical Capacitance



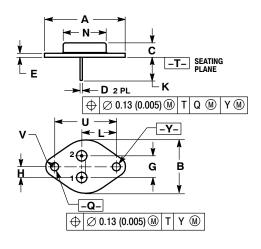






#### PACKAGE DIMENSIONS

TO-204AA (TO-3) CASE 1-07 **ISSUE Z** 



NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI

Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.

ALL RULES AND NOTES ASSOCIATED WITH REFERENCED TO-204AA OUTLINE SHALL APPLY. 3.

	INCHES		S MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	1.550 REF		39.37	REF
В		1.050		26.67
С	0.250	0.335	6.35	8.51
D	0.038	0.043	0.97	1.09
Е	0.055	0.070	1.40	1.77
G	0.430 BSC		10.92 BSC	
Н	0.215 BSC		5.46 BSC	
Κ	0.440	0.480	11.18	12.19
L	0.665 BSC		16.89 BSC	
N		0.830		21.08
Q	0.151	0.165	3.84	4.19
U	1.187	BSC	30.15 BSC	
۷	0.131	0.188	3.33	4.77

STYLE 1: PIN 1. BASE 2. EMITTER CASE: COLLECTOR

ON Semiconductor and 💷 are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

Phone: 421 33 790 2910

Phone: 81-3-5773-3850

Japan Customer Focus Center

#### PUBLICATION ORDERING INFORMATION

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support:

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative